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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/810,076	03/26/2004	Robert Duboc	P146-US	3509
26148 7	590 09/29/2005		EXAMINER	
REFLECTIVITY, INC.			LEWIS, MONICA	
350 POTRERO AVENUE SUNNYVALE, CA 94085			ART UNIT	PAPER NUMBER
BOINNI VIIBE	, 011 74005		2822	

DATE MAILED: 09/29/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)				
-	10/810,076	DUBOC ET AL.	(Dr.			
Office Action Summary	Examiner	Art Unit				
	Monica Lewis	2822				
The MAILING DATE of this communication app Period for Reply	pears on the cover sheet with the c	orrespondence addi	ess			
A SHORTENED STATUTORY PERIOD FOR REPL' THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply If NO period for reply is specified above, the maximum statutory period of Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be time within the statutory minimum of thirty (30) day will apply and will expire SIX (6) MONTHS from a cause the application to become ABANDONE	nely filed s will be considered timely. the mailing date of this com D (35 U.S.C. § 133).	munication.			
Status						
1) Responsive to communication(s) filed on 26 M	arch 2004.					
2a) This action is FINAL . 2b) ⊠ This	action is non-final.					
	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.					
Disposition of Claims						
4) ☐ Claim(s) 1-39 is/are pending in the application. 4a) Of the above claim(s) is/are withdray 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) 1-39 are subject to restriction and/or expressions.	wn from consideration.					
Application Papers						
9) The specification is objected to by the Examine	r.					
10) ☐ The drawing(s) filed on is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.						
Applicant may not request that any objection to the	• • •	• •				
Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Ex	, , , , ,		• •			
Priority under 35 U.S.C. § 119						
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the prior application from the International Bureau * See the attached detailed Office action for a list	s have been received. s have been received in Application ity documents have been receive (PCT Rule 17.2(a)).	on No ed in this National St	age			
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal Pa 6) Other:	te	52)			

1. This restriction is in response to the application filed March 26, 2004.

Election/Restrictions

2. This application contains claims directed to the following patentably distinct species of the claimed invention:

Embodiment I (Claims 1-4 and 17-19), directed to a semiconductor package comprising a deflectable element on a substrate, wherein the deflectable element is a mirror plate that is attached to a hinge, getter material and/or a lubricant disposed on the substrate and a package having the substrate with the deflectable element;

Embodiment II (Claims 1, 5-8 and 17-19), directed to a semiconductor package comprising a deflectable element on a substrate, getter material and/or a lubricant disposed on the substrate and a package having the substrate with the deflectable element and a package substrate having a cavity in which the substrate and the deflectable element is accommodated;

Embodiment III (Claims 1, 9 and 17-19), directed to a semiconductor package comprising a deflectable element on a substrate, getter material and/or a lubricant disposed on the substrate and wherein the lubricant material is disposed on a surface around the circumference;

Embodiment IV (Claims 1, 10 and 17-19), directed to a semiconductor package comprising a deflectable element on a substrate, getter material and/or a lubricant

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disposed on the substrate and wherein the lubricant material is disposed on a sidewall of the substrate;

Embodiment V (Claims 1, 11-14 and 17-19), directed to a semiconductor package comprising a deflectable element on a substrate, getter material and/or a lubricant disposed on the substrate and wherein the lubricant material is disposed in a capillary tubing formed on the substrate;

Embodiment VI (Claims 1, 15 and 17-19), directed to a semiconductor package comprising a deflectable element on a substrate, getter material and/or a lubricant disposed on the substrate and wherein the lubricant material is held by a container that is attached affixed to the substrate;

Embodiment VII (Claims 1, 16 and 17-19), directed to a semiconductor package comprising a deflectable element on a substrate, getter material and/or a lubricant disposed on the substrate and wherein the lubricant material is disposed in a trench on the substrate;

Embodiment VIII (Claim 20), directed to a semiconductor package comprising a substrate, a deflectable element attached to a deformable element held by the substrate, and a carrier disposed on the substrate;

Embodiment IX (Claims 21-24 and 37-39), directed to a semiconductor package comprising a deflectable element on a substrate, wherein the deflectable element is a mirror plate that is attached to a hinge a getter having a getter material disposed on the substrate, a lubricant material that is carried by the getter, a package having the substrate with the deflectable element;

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Embodiment X (Claims 21, 25-28 and 37-39), directed to a semiconductor package comprising a deflectable element on a substrate, wherein the deflectable element is a mirror plate that is attached to a hinge a getter having a getter material disposed on the substrate, a lubricant material that is carried by the getter, a package having the substrate with the deflectable element and a package substrate having a cavity in which the substrate and the deflectable element is accommodated;

Embodiment XI (Claims 21, 29 and 37-39), directed to a semiconductor package comprising a deflectable element on a substrate, wherein the deflectable element is a mirror plate that is attached to a hinge a getter having a getter material disposed on the substrate, a lubricant material that is carried by the getter, a package having the substrate with the deflectable element and wherein the lubricant material is disposed on a surface around the circumference; Embodiment XII (Claims 21, 30 and 37-39), directed to a semiconductor package comprising a deflectable element on a substrate, wherein the deflectable element is a mirror plate that is attached to a hinge a getter having a getter material disposed on the substrate, a lubricant material that is carried by the getter, a package having the substrate with the deflectable element and wherein the lubricant material is disposed on a side wall of the substrate; Embodiment XIII (Claims 21, 31-34 and 37-39), directed to a semiconductor package comprising a deflectable element on a substrate, wherein the deflectable element is a mirror plate that is attached to a hinge a getter having a getter

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material disposed on the substrate, a lubricant material that is carried by the getter, a package having the substrate with the deflectable element and wherein the lubricant material is disposed in a capillary tubing formed on the substrate; Embodiment XIV (Claims 21, 35 and 37-39), directed to a semiconductor package comprising a deflectable element on a substrate, wherein the deflectable element is a mirror plate that is attached to a hinge a getter having a getter material disposed on the substrate, a lubricant material that is carried by the getter, a package having the substrate with the deflectable element and wherein the lubricant material is held by a container that is attached affixed to the substrate; and

Embodiment XV (Claims 21, 36 and 37-39), directed to a semiconductor package comprising a deflectable element on a substrate, getter material and/or a lubricant disposed on the substrate and wherein the lubricant material is disposed in a trench on the substrate.

Applicant is required under 35 U.S.C. 121 to elect a single disclosed species for prosecution on the merits to which the claims shall be restricted if no generic claim is finally held to be allowable. Currently, none are generic.

Applicant is advised that a reply to this requirement must include an identification of the species that is elected consonant with this requirement, and a listing of all claims readable thereon, including any claims subsequently added. An argument that a claim is allowable or that all claims are generic is considered nonresponsive unless accompanied by an election.

Upon the allowance of a generic claim, applicant will be entitled to consideration of claims to additional species which are written in dependent form or otherwise include all the limitations of an allowed generic claim as provided by 37 CFR 1.141. If claims are added after the election, applicant must indicate which are readable upon the elected species. MPEP § 809.02(a).

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Should applicant traverse on the ground that the species are not patentably distinct, applicant should submit evidence or identify such evidence now of record showing the species to be obvious variants or clearly admit on the record that this is the case. In either instance, if the examiner finds one of the inventions unpatentable over the prior art, the evidence or admission may be used in a rejection under 35 U.S.C. 103(a) of the other invention.

3. Applicant is reminded that upon the cancellation of claims to a non-elected invention, the inventorship must be amended in compliance with 37 CFR 1.48(b) if one of the currently named inventors is no longer an inventor of at least one claim remaining in the application. Any amendment of inventorship must be accompanied by a request under 37 CFR 1.48(b) and by the fee under 37 CFR 1.17(i).

Conclusion

4. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Monica Lewis whose telephone number is 571-272-1838.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Amir Zarabian can be reached on 571-272-1852. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300 for regular and after final

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communications. Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

ML

September 27, 2005

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